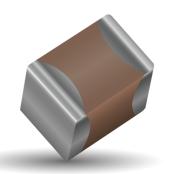
COG (NPO) Dielectric

General Specifications

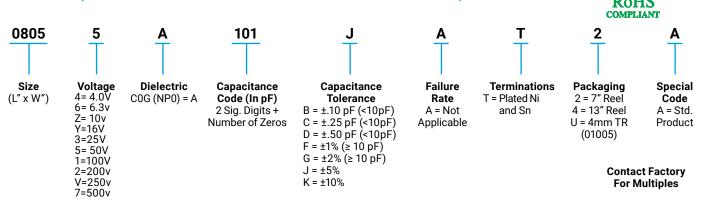


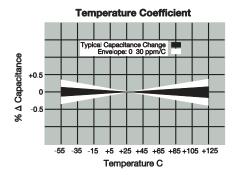


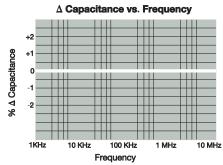
COG (NPO) is the most popular formulation of the "temperature-compensating," EIA Class I ceramic materials. Modern COG (NPO) formulations contain neodymium, samarium and other rare earth oxides.

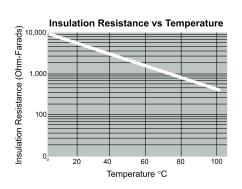
COG (NP0) ceramics offer one of the most stable capacitor dielectrics available. Capacitance change with temperature is 0 ±30ppm/°C which is less than ±0.3% C from -55°C to +125°C. Capacitance drift or hysteresis for COG (NPO) ceramics is negligible at less than ±0.05% versus up to ±2% for films. Typical capacitance change with life is less than ±0.1% for COG (NP0), one-fifth that shown by most other dielectrics.

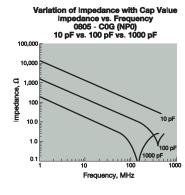
PART NUMBER (SEE PAGE 4 FOR COMPLETE PART NUMBER EXPLANATION)

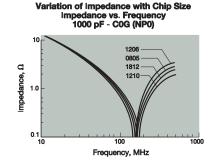


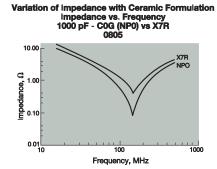












COG (NP0) Dielectric





Parame	ter/Test	NP0 Specification Limits	Measuring Conditions					
Operating Tem	perature Range	-55°C to +125°C	Temperature C	ycle Chamber				
•	itance Q	Within specified tolerance <30 pF: Q≥ 400+20 x Cap Value ≥30 pF: Q≥ 1000	Freq.: 1.0 MHz ± 10% for cap ≤ 1000 pF 1.0 kHz ± 10% for cap > 1000 pF Voltage: 1.0Vrms ± .2V					
Insulation	Resistance	10,000MΩ or 500MΩ - μ F, whichever is less	Charge device with rated voltage for 60 ± 5 secs @ room temp/humidity					
Dielectric	: Strength	No breakdown or visual defects	Charge device with 250% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max) Note: Charge device with 150% of rated voltage for 500V devices.					
	Appearance	No defects						
Resistance to	Capacitance Variation	±5% or ±.5 pF, whichever is greater	Deflectio Test Time: 3					
Flexure	Q	Meets Initial Values (As Above)	V					
Stresses	Insulation Resistance	≥ Initial Value x 0.3	90 mm					
Solder	rability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic sold 0.5 sec					
	Appearance	No defects, <25% leaching of either end terminal						
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Dip device in eutectic solder at 260°C for 60sec- onds. Store at room temperature for 24 ± 2hours before measuring electrical					
Resistance to	Q	Meets Initial Values (As Above)						
Solder Heat	Insulation Resistance	Meets Initial Values (As Above)	properties.	e measuring electrical				
	Dielectric Strength	Meets Initial Values (As Above)						
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes				
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Step 2: Room Temp	≤ 3 minutes				
Thermal Shock	Q	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes				
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes				
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 hours at room temperature					
	Appearance	No visual defects	-					
	Capacitance Variation	≤ ±3.0% or ± .3 pF, whichever is greater	Charge device with twice rated voltage in test chamber set at 125°C ± 2°C for 1000 hours (+48, -0). Remove from test chamber and stabilize at					
Load Life	Q (C=Nominal Cap)	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C						
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	room temperatu before me	re for 24 hours				
	Dielectric Strength	Meets Initial Values (As Above)						
	Appearance	No visual defects						
	Capacitance Variation	≤ ±5.0% or ± .5 pF, whichever is greater	Store in a test chamber s	et at 85°C ± 2°C/ 85% +				
Load Humidity	Q	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C	5% relative humidity for 1000 hours (+48, -0) with rated voltage applied. Remove from chamber and stabilize at room temperature for 24 ± 2 hours before measuring.					
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)						
	Dielectric Strength	Meets Initial Values (As Above)						

COG (NP0) Dielectric





PREFERRED SIZES ARE SHADED

SIZE	0201 0402				0603						0805						1206								
Solderin	ng	Reflow Only		w Only	Ref	flow/Wa				eflow/W					Refl	ow/Wave			Reflow/Wave						
Packagin		All Paper		Paper				All Paper				Paper/Embossed						Paper/Embossed							
(L) Length	mm (in.)	0.40 ± 0.02 (0.016 ± 0.0008)	0.60 ±	± 0.03 ± 0.001)		00 ± 0.1 40 ± 0.0				.60 ± 0. 063 ± 0.						0.20 / 0.20 0.008 / 0.008	8)					3.20 ± 0. .126 ± 0.			
W) Width	mm (in.)	0.20 ± 0.02 (0.008 ± 0.0008)	0.30 ± (0.011 ±			50 ± 0.1 20 ± 0.0				0.81 ± 0. 032 ± 0.						25 ± 0.20 19 ± 0.008	8)		1.60 ± 0.20 (0.063 ± 0.008)						
(t) Terminal	mm (in.)	0.10 ± 0.04 (0.004 ± 0.0016)	0.15 ±	± 0.05 ± 0.002)		25 ± 0.1 10 ± 0.0		0.35 ± 0.15							0.50 ± 0.25 (0.020 ± 0.010)										
	WVDC	16	25	50	16	25	50	16	25	50	100	200	16	25	50	100	200	250	16	25	50	100	200	250	500
Сар	0.5		Α	Α	С	С	С	G	G	G	G		J	J	J	٦	J	J	J	J	J	J	J	٦	J
(pF)	1.0	В	A	A	C	С	C	G	G	G	G		J	J	J	J	J	J	J	J	J	J	J	J	J
	1.2 1.5	B B	A	A	C	C	C	G G	G G	G G	G G		J	J	J	J	J	J	J	J	J	J	J	J	J
	1.8	В	A	A	C	С	c	G	G	G	G		J	J	J	J	J	J	J	J	J	J	J	J	J
	2.2	В	Α	Α	C	С	С	G	G	G	G		J	J	J	J	J	J	J	J	J	J	J	J	J
	2.7	В	A	A	C	С	С	G	G	G	G		J	J	J	J	J	J	J	J	J	J	J	J	J
	3.3 3.9	B B	A	A	C	C	C	G G	G G	G G	G G		J	J	J	J	J	J	J	J	J	J	J	J	J
1	4.7	В	A	A	C	c	C	G	G	G	G		J	.1	.1	J	J	.1	.l	J				.1	
	5.6	В	A	A	C	C	c	G	G	G	G		J	J	J	J	J	J	J	J	J	J	J	J	J
	6.8	В	Α	Α	C	С	С	G	G	G	G		J	J	J	J	J	J	J	J	J	J	J	J	J
	8.2	В	A	A	C	С	C	G	G	G	G		J	J	J	J	J	J	J	J	J	J	J	J	J
	10 12	B B	A	Α Δ	C	C	C	G G	G G	G G	G G	G G	J	J	J	J	J	J	J	J	J	J	J	J	J
	15	В	A	A		C	C	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J.	J
	18	В	A	A	C	С	C	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J	J
	22	В	Α	Α	c	С	С	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J	J
	27	В	A	A	C	С	C	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J	J
	33 39	B B	A	A	C	C	C	G G	G G	G G	G G	G G	J	J	J	J	J	J	J	J	J	J	J	J	J
1	47	В	Â	l â	C	c	C	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J	J
	56	В	A	A	C	С	C	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J	J
	68	В	Α	Α	C	С	С	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J	J
<u> </u>	82	В	A	A	С	С	C	G	G	G	G	G	J	J	J	J	J	J	J	J	J	J	J	J	J
	100 120	В	A	A	C	C	C	G G	G G	G G	G G	G G	J	J	J	J	J	J	J	J	J	J	J	J	J
1	150		A	A	c	c	c	G	G	G	G	G	J	J	Ĵ	Ĵ	J	Ĵ	J	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ
	180		Α	Α	C	С	С	G	G	G	G	G	J	J	J	J	J	N	J	J	J	J	J	J	J
	220		Α	A	C	С	С	G	G	G	G	G	J	J	J	J	N	N	J	J	J	J	J	J	J
<u> </u>	270		<u> </u>		С	С	C	G	G	G	G		J	J	J	J	N	N	J	J	J	J	J	J	J
	330 390				C	C	C	G G	G G	G G	G G		J	J	J	J	N N	N N	J	J	J	J	J	J	J
	470				c	C	c	G	G	G	G		J	Ĵ	Ĵ	J	N	N	J	Ĵ	Ĵ	Ĵ	Ĵ	J	Ĵ
	560				С	С	С	G	G	G	G		J	J	J	J	N	N	J	J	J	J	J	J	J
	680				С	С	С	G	G	G	G		J	J	J	J	N	N	J	J	J	J	J	J	J
	750				C	C	C	G G	G	G	G		J	J	J	J	N	N	J	J	J	J	J	J	J
	820 1000			+	C	C	C	G	G	G G	G G		J	J	J	J	N N	N N	J	J	J	J	J	J	J
	1200							G	G	G			Ĵ	Ĵ	Ĵ	Ĵ	P	P	J	J	J	Ĵ	Ĵ	Ĵ	Ĵ
	1500					L		G	G	G			J	J	J	J	Р	Р	J	J	J	М	Q	Р	Р
	1800]			G	G	G			٦ ر	J	J	٦ ر	Р	Р	J	J	М	P	Q	Р	Р
	2200 2700							G	G G	G G			P P	P P	P P	P P	P P	P P	J	J	M M	P P	QQ	P P	P P
	3300		\vdash	+	\vdash	-		G	G	G			P	P	P	P	P	P	J	J	M	P	Q	X	P
	3900							G	G	G			P	P	P	P	P	P	J	J	M	P	X	X	X
	4700		<u> </u>	<u> </u>	ш	<u> </u>		G	G	G			Р	Р	Р	Р	Р	Р	J	J	М	Р	Х	Х	Х
	5600]								Р	Р	Р				J	J	М	P	X	X	X
	6800 8200					i '							P P	P P	P P				M P	M P	M P	P P	X	X	Х
Сар	0.010		 	+	$\vdash \vdash \vdash$								P	P	P				P	P	P	P	X	X	
(μF)	0.012												P	P	P				X	X	X	x			
	0.015		1	1	_	ı İ	I												Х	Х	Х	Х			
	0.018	_1_		\sim	W-	>	-												X	X	X	X			
	0.022 0.027	<u> </u>	<		رر	1-													X	X	X	Х			
	0.027		$\overline{}$)) _ੑੈ⊤													X	X	X	Х			
	0.039	_	_ 1				-												Χ	Х	Х				
	0.047	<u> </u>	\sim	1															X	X	X				
	0.068 0.082		4	£															Х	X	Х				
	0.082		'	1		1	I												Х	Х	Х				
					+		_					_													
WVDC SIZE		16 0101 *	25	50	16	25	50	16	25	50	100	200	16	25	50	100	200	250	16	25	50	100	200	250	500

Letter	Α	В	С	Е	G	J	K	М	N	Р	Q	Х	Υ	Z			
Max. Thickness	0.33 (0.013)	0.22 (0.009)	0.56 (0.022)	0.71 (0.028)	0.90 (0.035)	0.94 (0.037)	1.02 (0.040)	1.27 (0.050)	1.40 (0.05 5)	1.52 (0.060)	1.78 (0.070)	2.29 (0.090)	2.54 (0.100)	2.79 (0.110)			
	PAPER							EMBOSSED									

COG (NP0) Dielectric





PREFERRED SIZES ARE SHADED

SIZE				1210					1812				1825			2220			2225		
Soldering	g			Reflow Only	/				Reflow Only	,			Reflow Onl	y		Reflow Onl	у	R	Reflow Only		
Packagin	-			per/Embos					II Embosse			All Embossed				II Embosse			l Embossed		
(L) Length	mm (in.)		(0	3.20 ± 0.20 0.126 ± 0.00	18)			(0	4.50 ± 0.30 .177 ± 0.01	2)	_	4.50 ± 0.30 (0.177 ± 0.012)			5.70 ± 0.40 (0.225 ± 0.016)			5.72 ± 0.25 (0.225 ± 0.010)			
W) Width	mm (in.)			2.50 ± 0.20 0.098 ± 0.00			3.20 ± 0.20 (0.126 ± 0.008)					((6.40 ± 0.40 0.252 ± 0.01		5.00 ± 0.40 (0.197 ± 0.016)			6.35 ± 0.25 (0.250 ± 0.010)			
(t) Terminal	mm			0.50 ± 0.25					0.61 ± 0.36				0.61 ± 0.36			0.64 ± 0.39			0.64 ± 0.39	-	
.,	(in.) WVDC	25	50	0.020 ± 0.01 100	200	500	25	50	.024 ± 0.01	200	500	50	0.024 ± 0.01 100	200	50	.025 ± 0.01	200	50	025 ± 0.015	200	
Сар	3.9	20	- 55	100	200	000		- 00	100	200	000	- 55	100	200	- 55	100	200			200	
(pF)	4.7																			\square	
	5.6 6.8																				
	8.2																			1	
	10	М	М	М	М	М	Р	Р	Р	Р	Р						7		101		
	12	М	М	М	М	М	Р	Р	Р	Р	Р					L			\\\\		
	15 18	M M	M M	M M	M M	M M	P P	P P	P P	P P	P P					- \		.)) (1 -	\vdash	
	22	M	M	M	M	M	P	P	P	P	P					_	_) .			1	
	27	M	М	М	М	М	Р	Р	Р	Р	Р					L	مدا		_		
	33	М	М	М	М	М	P	P	P	P	P						, [_] t	l	. 7		
	39 47	M P	M P	M P	M P	M P	P P	P P	P P	P P	P P										
	56	P	P	P	P	P	P	P	P	P	P										
	68	Р	Р	Р	Р	Р	Р	Р	Р	Р	Р									1 1	
	82	P P	P P	P P	P P	P P	P P	P P	P	P P	P P										
	100 120	P	P	P	P	P	P	P	P P	P	P									1	
	150	P	P	P	P	P	P	P	P	P	P										
	180	P	P	P	P	Р	P	P	P	Р	P										
	220 270	P P	P P	P P	P P	P P	P P	P P	P	P P	P P										
	330	P	P	P	P	P	P	P	P	P	P										
	390	Р	Р	Р	Р	Р	Р	Р	Р	Р	Р									1 1	
	470	P P	P	P	P	P	P P	P P	P P	P P	P										
	560 680	P	P P	P P	P P	P P	P	P	P	P	P P									1	
	820	P	P	P	P	P	P	P	P	P	P										
	1000	P	P	P	P	P	P	P	P	Р	P	М	M	М				М	М	P	
	1200 1500	P P	P P	P P	P P	P P	P P	P P	P	P P	P P	M M	M M	M M				M M	M M	P P	
	1800	P	P	P	P	P	P	P	P	P	P	M	M	M				M	M	P	
	2200	Р	Р	Р	Р	Р	Р	Р	Р	Р	Р	Х	X	М				М	М	Р	
	2700 3300	P P	P P	P P	P P	P P	P P	P P	P P	P P	Q	X	X	M X	_		X	M M	M M	P	
	3900	P	P	P	P	P	P	P	P	P	Q	X	X	X			X	M	M	P	
	4700	P	Р	Р	Р	Р	Р	Р	P	Р	Y	X	X	Х	Х	Х	Х	М	M	P	
	5600	P	Р	Р	P	P	Р	Р	Р	Р	Y	Х	Х	X	Х	Х	Х	М	М	Р	
	6800 8200	P P	P P	P P	X	X X	P P	P P	QQ	Q Q	Y	X	X	X	X	X	X	M M	M M	P P	
Сар	0.010	P	P	X	X	X	P	P	Q	Q	Y	X	X	X	X	X	X	M	M	P	
(μ F)	0.012	Χ	x	x	x	Х	Р	Р	Q	Х	Y	x	X	х	X	x	x	М	М	Р	
	0.015	X	X	X	Z	Z	P	P	Q	X	Y	X	X	X	X	X	X	M	M	Y	
	0.018 0.022	X X	X	Z Z	Z Z		P P	P P	X	X X	Υ	X	X	X	X	X	X	M M	M Y	Y	
	0.027	X	Z	Z	Z	L	. q	X	X	Z		X	X	Y	X	X		P	Y	Y	
	0.033	X	Z	Z	Z		Q	Х	X	Z		Х	Х		Х	Х		Х	Υ	Υ	
	0.039 0.047	Z Z	Z Z	Z Z			X X	X X	Z Z	Z Z		X			Y Y			X X	Y Z	Υ	
	0.047						Z	Z	Z	L		^			Z	 		X	Z		
	0.082						Z	Z	Z						Z			Χ	z		
	0.1 WVDC	25	50	100	200	500	Z 25	Z 50	Z 100	200	500	FO	100	200	50	100	200	Z	Z 100	200	
	SIZE	25	30	1210	200	500	25	50	100 1812	200	500	50	100 1825	200	30	100 2220	200	50	2225	200	

Letter	Α	В	С	E	G	J	K	М	N	Р	Q	Х	Υ	Z		
Max.	0.33	0.22	0.56	0.71	0.90	0.94	1.02	1.27	1.40	1.52	1.78	2.29	2.54	2.79		
Thickness	(0.013)	(0.009)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.055)	(0.060)	(0.070)	(0.090)	(0.100)	(0.110)		
	PAPER							FMROSSED								